

## AA3021ES

3.0 x 2.0 mm Surface Mount LED Lamp



## DESCRIPTION

• The High Efficiency Red source color devices are Made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode

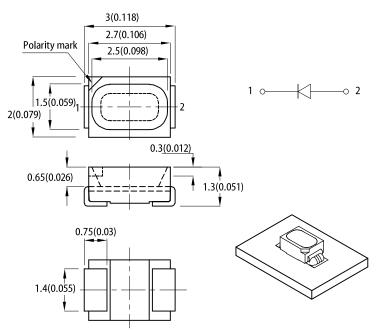
### **FEATURES**

- 3.0 mm x 2.0 mm, 1.3 mm high, only minimum space required
- Suitable for compact optoelectronic applications
- Low power consumption
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- RoHS compliant

#### **APPLICATIONS**

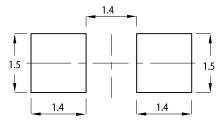
- Backlight
- · Status indicator
- · Home and smart appliances
- · Wearable and portable devices
- · Healthcare applications

## PACKAGE DIMENSIONS



#### **RECOMMENDED SOLDERING PATTERN**

(units : mm; tolerance :  $\pm 0.1$ )



Notes:

1. All dimensions are in millimeters (inches).

Tolerance is ±0.2(0.008") unless otherwise noted.
 The specifications, characteristics and technical data described in the datasheet are subject to

change without prior notice. 4. The device has a single mounting surface. The device must be mounted according to the specifications.

#### **SELECTION GUIDE**

Part Number	Emitting Color	Lens Type	lv (mcd) @ 20mA <sup>[2]</sup>		Viewing Angle <sup>[1]</sup>	
Fait Number	(Material)	Lens Type	Min.	Тур.	201/2	
AA3021ES	High Efficiency Red (GaAsP/GaP)	Water Clear	12	30	120°	
			*8	*18	120	

Notes

1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
 2. Luminous intensity / luminous flux: +/-15%.
 \* Luminous intensity value is traceable to CIE127-2007 standards.

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### ELECTRICAL / OPTICAL CHARACTERISTICS at T<sub>A</sub>=25°C

Parameter	Symbol	Emitting Color	Value		Unit
Farameter		Emitting Color	Тур.	Max.	Unit
Wavelength at Peak Emission $I_F$ = 20mA	$\lambda_{peak}$	High Efficiency Red	627	-	nm
Dominant Wavelength I <sub>F</sub> = 20mA	$\lambda_{dom}$ <sup>[1]</sup>	High Efficiency Red	617	-	nm
Spectral Bandwidth at 50% $\Phi$ REL MAX I <sub>F</sub> = 20mA	Δλ	High Efficiency Red	45	-	nm
Capacitance	С	High Efficiency Red	15	-	pF
Forward Voltage $I_F$ = 20mA	V <sub>F</sub> <sup>[2]</sup>	High Efficiency Red	2	2.5	V
Reverse Current (V <sub>R</sub> = 5V)	I <sub>R</sub>	High Efficiency Red	-	10	μΑ

Notes:

The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
 Forward voltage: ±0.1V.
 Wavelength value is traceable to CIE127-2007 standards.
 Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

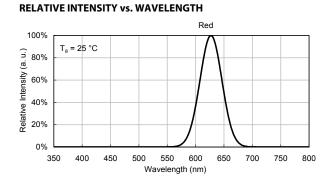
## ABSOLUTE MAXIMUM RATINGS at T<sub>A</sub>=25°C

Parameter	Symbol	Value	Unit
Power Dissipation	P <sub>D</sub>	75	mW
Reverse Voltage	V <sub>R</sub>	5	V
Junction Temperature	Tj	125	°C
Operating Temperature	T <sub>op</sub>	-40 to +85	°C
Storage Temperature	T <sub>stg</sub>	-40 to +85	°C
DC Forward Current	I <sub>F</sub>	30	mA
Peak Forward Current	I <sub>FM</sub> <sup>[1]</sup>	160	mA
Electrostatic Discharge Threshold (HBM)	-	8000	V

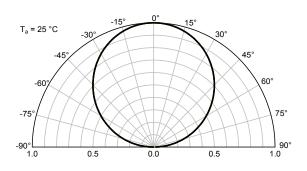
Notes: 1. 1/10 Duty Cycle, 0.1ms Pulse Width. 2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

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## **TECHNICAL DATA**



#### SPATIAL DISTRIBUTION



2.5

2.0

1.5

1.0

0.5

0.0

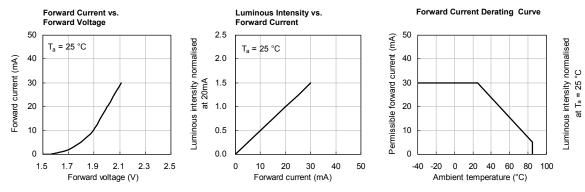
Luminous Intensity vs.

Ambient Temperature

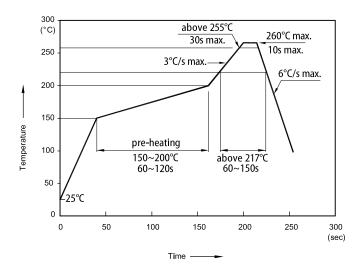
-40 -20 0 20 40 60 80 100

Ambient temperature (°C)

## **HIGH EFFICIENCY RED**



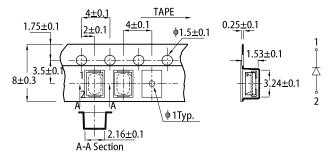
#### **REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS**



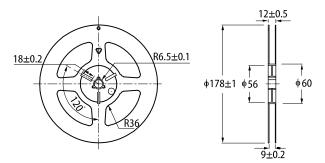
Notes:

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
- The maximum number of reflow soldering passes is 2 times.
  Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

TAPE SPECIFICATIONS (units : mm)



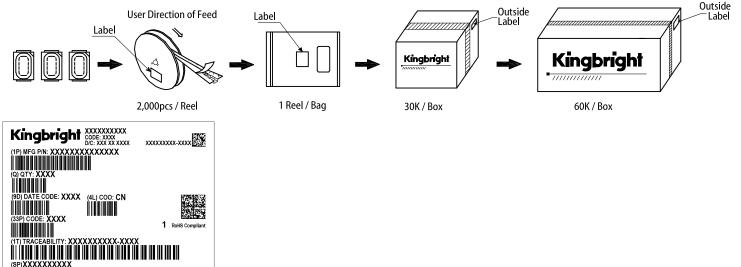
#### REEL DIMENSION (units : mm)



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## AA3021ES

#### **PACKING & LABEL SPECIFICATIONS**



#### HANDLING PRECAUTIONS

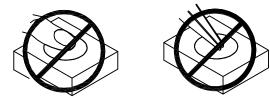
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



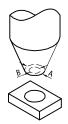
precise pickup and avoid damage during production.

2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



 Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.





#### **PRECAUTIONARY NOTES**

substances.

5.

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.

4-1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.4-2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.4-3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure

As silicone encapsulation is permeable to gases, some corrosive substances such as H<sub>2</sub>S might corrode silver

plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such

- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
  When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
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